US April 2, 1997	
<u>Description</u>	<u>HS</u>
With respect to any product described in Attachment B to the Annex to the Ministerial Declaration on Trade in Information Technology Products (WT/MIN(96)/16), to the extent not specifically provided for in this Schedule, the customs duties on such product, as well any other duties and charges of any kind (within the meaning of Article II:1(b) of the General Agreement on Tariffs and Trade 1994), shall be bound and eliminated, as set forth in paragraph 2(a) of the Annex to the Declaration, wherever the product is classified.	
Quartz reactor tubes and holders designed for insertion into diffusion and oxidation furnaces for production of semiconductor wafers	70171030,70200030
Chemical vapor deposition apparatus for semiconductor production	84798985
Parts of chemical vapor deposition apparatus for semiconductor production	84799095A
Apparatus for stripping or cleaning semiconductor wafers	84569970
Lasercutters for cutting contacting tracks in semiconductor production by laser beam	84561060
Machines for sawing monocrystal semiconductor boules into slices, or wafers into chips	84641000
Parts for machines for sawing monocrystal semiconductor boules into slices, or wafers into chips	84669110,84669150A,84661040,84662040,84663040A, 84663040B
Parts of dicing machines for scribing or scoring semiconductor wafers	84669110,84669150A,84661040,84662040,84663040A, 84663040B
Parts of lasercutters for cutting contacting tracks in semiconductor production by laser beam	84669315,84669347,84669360,84669385,84661040,84662040, 84663040A, 84663040B
Parts of apparatus for stripping or cleaning semiconductor wafers	84669315,84669347,84669360,84669385,84662040,84663040A , 84663040B
Encapsulation equipment for assembly of semiconductors	84771060,84774040,84775940
Parts of encapsulation equipment	84779015,84779035,84779055, 84779075

Automated machines for transport, handling and storage of semiconductor wafers, wafer cassettes, 84283300A,84283900A,84289000A,84282000A wafer boxes and other material for semiconductor devices

84798985

Apparatus for physical deposition by sputtering on semiconductor wafers

<u>Description</u>	<u>HS</u>
Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	84248930, 84649010, 84649060, 84798985, 84248950
Die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors	85158000A, 84798985
Encapsulation equipment for assembly of semiconductors	84771060, 84774040, 84775940
Machines for bending, folding and straightening semiconductor leads	84622140, 84622940
Physical deposition apparatus for semiconductor production	84798985
Spinners for coating photographic emulsions on semiconductor wafers	84798985
Part of apparatus for physical deposition by sputtering on semiconductor wafers	84799095A
Parts for die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors	85159010, 84799095A
Parts for spinners for coating photographic emulsions on semiconductor wafers	84799095A
Parts of apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	84249090A, 84669110, 84669150A, 84662040, 84663040A, 84663040B, 84799095A
Parts of automated machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	84313900A
Parts of encapsulation equipment for assembly of semiconductors	84779015, 84779035, 84779055, 84779075
Parts of machines for bending, folding and straightening semiconductor leads	84669420, 84669440, 84669455, 84669475, 84661040, 84662040, 84663040A, 84663040B
Parts of physical deposition apparatus for semiconductor production	84799095A
Apparatus for rapid heating of semiconductor wafers	85143060
Parts of apparatus for rapid heating of wafers	85149000A
Wafer probers	85369040
Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	84248930, 84649010, 84649060, 84798985, 84248950, 84798987
Parts of apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	84249090A, 84669110, 84669150A, 84799095A, 84662040, 84663040A, 84663040B

<u>Description</u>	<u>HS</u>
Optical stereoscopic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	90314100
Photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	90314100
Parts and accessories of optical stereoscopic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	90319054
Parts and accessories of photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	90319054
Electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	90318040
Parts and accessories of electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	90319070
Pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates	90172050
Parts and accessories for pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates	90179000D
Parts of such pattern generating apparatus	90179000D
Computers: automatic data processing machines capable of 1) storing the processing program or programs and at least the data immediately necessary for the execution of the program; 2) being freely programmed in accordance with the requirements of the user; 3) performing arithmetical computations specified by the user; and 4) executing, without human intervention, a processing program which requires them to modify their execution, by logical decision during the processing run. The agreement covers such automatic data processing machines whether or not they are able to receive and process with the assistance of central processing unit telephony signals, television signals, or other analogue or digitally processed audio or video signals. Machines performing a specific function other than data processing, or incorporating or working in conjunction with an automatic data processing machine, and not otherwise specified under Attachment A or B, are not covered by this agreement.	84711000A, 8711000B, 84713000A, 84713000B, 84714100A, 84714100B, 84714910A, 84714910A, 84715000A, 84715000B, 84715000C
Electric amplifiers when used as repeaters in line telephony products falling within this agreement, and parts thereof	85184010, 85189020
Flat panel display devices (including LCD, Electro Luminescence, Plasma, Vacuum-Fluorescence and other technologies) for products falling within this agreement, and parts thereof.	84716030, 84716045A, 84716045B, 84714915A, 84714915B, 84714924, 84714929A, 84714929B, 84716010A, 84716010B, 84733010, 84733020, 84733050, 85312000, 85318070B, 85319010, 85319070, 85438992, 85439064, 85439084, 90138070, 90139050

Description HS

Network equipment: Local Area Network (LAN) and Wide Area Network (WAN) apparatus, including 84718010, 84714960 those products dedicated for use solely or principally to permit the interconnection of automatic data processing machines and units thereof for a network that is used primarily for the sharing of resources such as central processor units, data storage devices and input or output units - including adapters, hubs, in-line repeaters, converters, concentrators, bridges and routers, and printed circuit assemblies for physical incorporation into automatic data processing machines and units thereof.

Monitors: display units of automatic data processing machines with a cathode ray tube with a dot screen pitch smaller than 0,4 mm not capable of receiving and processing television signals or other analogue or digitally processed audio or video signals without assistance of a central processing unit of a computer as defined in this agreement. The agreement does not, therefore, cover televisions, including high definition televisions.

84716010A, 84716010B, 84716035A, 84716035B, 84716045A, 84716045B, 84714915A, 84714915B, 84714926A, 84714926B, 84714929A, 84714929B

Optical disc storage units, for automatic data processing machines (including CD drives and DVDdrives), whether or not having the capability of writing/recording as well as reading, whether or not in their own housings.

84714950A, 84714950B, 84717060, 84717090A, 84717090B

Paging alert devices, and parts thereof.

85279085A, 85279085B, 85318040, 85252030A, 85252030B, 85299023A, 85299076A, 85299085A, 85291070A, 85291070B, 85319010, 85319070

Plotters whether input or output units of HS heading No 8471 or drawing or drafting machines of HS 84716051A, 84716051B, 84716052A, 84716052B, 84716053A, heading No 9017.

84716053B, 84716054A, 84716054B, 84716055A, 84716055B, 84716056A, 84716056B, 84716057A, 84716057B, 84716061, 84716062, 84716063, 84716064, 84716065, 84716066, 84716067, 84713937A, 84713937B, 84714931A, 84714931B, 84714932A, 84714932B, 84714933A, 84714933B, 84714934A, 84714934B, 84714935A, 84714935B, 84714936A, 84714936B, 90171040, 90172070

Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and 85202000, 85229045, 85299023A, 85319010, 85389010, integrated circuits and micro assemblies of heading 8542.

84715000A, 84715000B, 84715000C, 84733010, 84735030, 84731020, 84732100, 84732900, 84734010, 85044060, 85044085, 85049020, 85049065, 85175010, 85179008, 85179036, 85179038, 85179044, 85189020, 85189060, 85439064, 90099010, 90099050, 90139050, 90179000A, 90179000D, 90179000E, 90269020A, 90269020B, 90279045, 90279054B, 90279064, 90309064, 90319054

Projection type flat panel display units used with automatic data processing machines which can display digital information generated by the central processing unit.

84716030, 84714924

Proprietary format storage devices including media therefor for automatic data processing machines, with or without removable media and whether magnetic, optical or other technology, including Bernoulli Box, Syquest, or Zipdrive cartridge storage units.

84717010, 84717020, 84717030A, 84717030B, 84717040, 84717050A, 84717050B, 84717060, 84717090A, 84717090B, 84714950A, 84714950B, 85232000, 85239000, 85243100, 85243940, 85249100, 85249940A

<u>Description</u>	<u>HS</u>
Multimedia upgrade kits for automatic data processing machines, and units thereof, put up for retail sale, consisting of, at least, speakers and/or microphones as well as a printed circuit assembly that enables the ADP machines and units thereof to process audio signals (sound cards).	84733010, 85175010
Set top boxes which have a communication function: a microprocessor-based device incorporating a modem for gaining access to the Internet, and having a function of interactive information exchange	85175010,8 5251010, 85281292
Deflash machines for cleaning and removing contaminants from the metal leads of semiconductor packages prior to the electronplating process	84243090A, 84248950, 84659940, 84798985
Dicing Machines for scribing or scoring semiconductor wafers	84641000, 84649010
Parts of grinding, polishing and lapping machines for processing of semiconductor wafers	84669110, 84669150A, 84661040, 84662040, 84663040A, 84663040B
Parts of focused ion beam milling machines to produce or repair masks and reticles for patterns on semiconductor devices	84669315, 84669347, 84669360, 84669385, 84661040, 84662040, 84663040A, 84663040B
Parts of machines for working any material by removal of material, by laser or other lights or photon beam in the production of semiconductor wafers	84669315, 84669347, 84669360, 84669385, 84661040, 84662040, 84663040A, 84663040B
Parts of machines for dry-etching patterns on semiconductor materials	84669315, 84669347, 84669360, 84669385, 84662040, 84663040A, 84663040B
Apparatus for projection, drawing or plating circuit patterns on sensitized semiconductor materials and flat panel displays	90104100, 90104200, 90104900, 90105060
Optical instruments and appliances for inspecting semiconductor wafers or devices or for inspecting masks, photomasks or reticles used in manufacturing semiconductor devices	90314100, 90314970